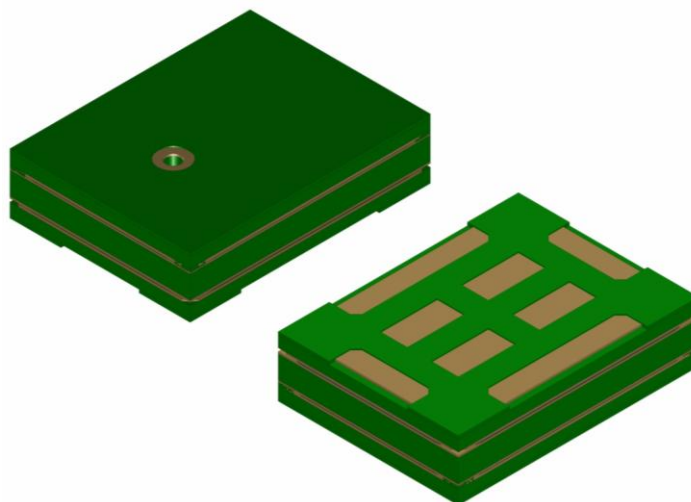


Digital High-SNR SiSonic™ Microphone



The SPK0838HT4H-B is a miniature, high-performance, low power, top port silicon digital microphone with a single bit PDM output. Using Knowles' proven high performance SiSonic™ MEMS technology, the SPK0838HT4H-B consists of an acoustic sensor, a low noise input buffer, and a sigma-delta modulator. These devices are suitable for applications such as cellphones, smart phones, laptop computers, sensors, digital still cameras, portable music recorders, and other portable electronic devices where excellent audio performance and RF immunity are required. The high Signal-to-Noise-Ratio (SNR) of the SPK0838HT4H-B enhances the performance of far-field applications and many complex, multi-microphone algorithms.

Features:

- High Signal to Noise Ratio of 64dB(A)
- Flat Frequency Response up to 20kHz
- Low Current
- RF Shielded
- PDM Output
- Supports Dual Multiplexed Channels
- Ultra-Stable Performance
- Standard SMD Reflow
- Omnidirectional

SPK0838HT4H-B

1. ABSOLUTE MAXIMUM RATINGS

Parameter	Absolute Maximum Rating	Units
V_{DD} , DATA to Ground	-0.3, +5.0	V
CLOCK to Ground	-0.3, +5.0	V
SELECT to Ground	-0.3, +5.0	V
Input Current	± 5	mA
Short Circuit Current to/from DATA	Indefinite to Ground or V_{DD}	sec
Temperature Range	-40 to +100	°C

Stresses exceeding these “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation at these or any other conditions beyond those indicated under “Acoustic & Electrical Specifications” is not implied. Exposure beyond those indicated under “Acoustic & Electrical Specifications” for extended periods may affect device reliability.

2. ACOUSTIC & ELECTRICAL SPECIFICATIONS

TEST CONDITIONS: 23 \pm 2°C, 55 \pm 20% R.H., V_{DD} =1.8 V, F_{CLOCK} =2.4 MHz, SELECT pin grounded, no load, unless otherwise indicated

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage ¹	V_{DD}		1.6	1.8	3.6	V
Supply Current ²	I_{DD}	$V_{DD} = 1.8V$	-	500	600	μA
Supply Current ^{1,2}	I_{DD}	$V_{DD} = 3.6V$	-	600	700	μA
Sleep Current	I_{SLEEP}	$F_{CLOCK} < 1 \text{ kHz}$, $V_{DD} = 1.8V$	-	4	8	μA
Sleep Current ¹	I_{SLEEP}	$F_{CLOCK} < 1 \text{ kHz}$, $V_{DD} = 3.6V$	-	5	10	μA
Sensitivity ¹	S	94 dB SPL @ 1 kHz	-29	-26	-23	dBFS
Signal to Noise Ratio	SNR	94 dB SPL @ 1 kHz, A-weighted	-	64	-	dB(A)
Total Harmonic Distortion	THD	94 dB SPL @ 1 kHz, S = Typ	-	0.25	1	%
Acoustic Overload Point	AOP	10% THD @ 1 kHz, S = Typ, $V_{DD} = 3.6V$	118	121	-	dB SPL
Power Supply Rejection Ratio	PSRR	200 mVpp sinewave @ 1 kHz	-	65	-	dBFS /V
Power Supply Rejection	PSR+N	100 mVpp square wave @ 217 Hz, A-weighted	-	-87	-	dBFS (A)
DC Output		Fullscale = ± 100	-	-5	-	% FS
Directivity			Omnidirectional			
Polarity		Increasing sound pressure	Increasing density of 1's			

SPK0838HT4H-B

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Data Format			½ Cycle PDM			
Logic Input High	V _{IH}		0.65xV _{DD}	-	3.6	V
Logic Input Low	V _{IL}		GND-0.3	-	0.35xV _{DD}	V
Logic Output High	V _{OH}	I _{OUT} = 2 mA	0.7xV _{DD}	-	V _{DD}	V
Logic Output Low	V _{OL}	I _{OUT} = 2 mA	GND	-	0.3xV _{DD}	V
SELECT (high)			V _{DD} -0.2	-	3.6	V
SELECT (low)			GND	-	GND+0.2	V
Short Circuit Current	I _{SC}	Grounded DATA pin	2	-	10	mA
Output Load	C _{LOAD}		-	-	160	pF
Fall-asleep Time ^{3,4}		F _{CLOCK} < 1 kHz	-	-	10	ms
Wake-up Time ^{3,5}		F _{CLOCK} ≥ 1 MHz	-	-	20	ms
Startup Time ³		Powered Down→Active Mode	-	-	50	ms
Restart Time ³		Active→Powered Down→Active Mode	-	-	125	ms
Clock Frequency	F _{CLOCK}		1.0	-	3.25	MHz
Clock Duty Cycle			40	-	60	%
Clock Rise/Fall Time	t _{EDGE}		-	-	13	ns
Data Time	t _{SRTUP} + t _{EDGE}	Max C _{LOAD}	47	-	-	ns
Delay Time to Data Line Driven	t _{DD}		18	-	-	ns
Delay Time to Valid Data	t _{DV}	Max C _{LOAD}	-	-	115	ns
Delay Time to High Z ⁶	t _{DZ}		0	-	16	ns

¹ 100% tested.

² I_{DD} varies with C_{LOAD} according to: ΔI_{DD} = 0.5*V_{DD}*ΔC_{LOAD}*F_{CLOCK}.

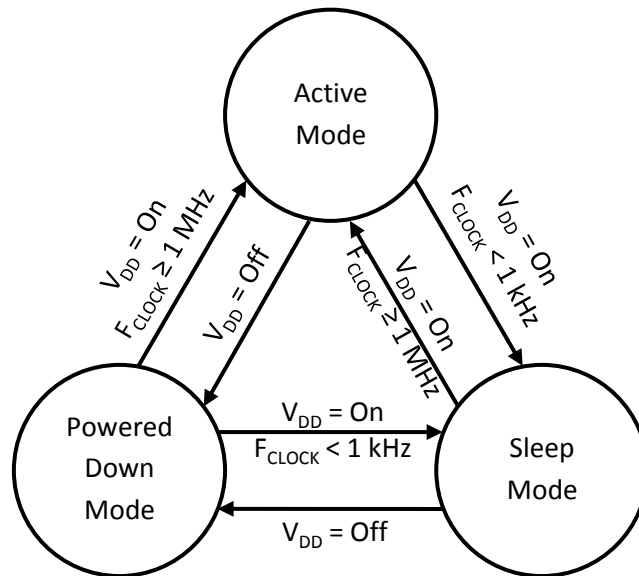
³ Valid microphones states are: Powered Down Mode (mic off), Sleep Mode (low current, DATA = high-Z, fast startup), and Active Mode (normal operation).

⁴ Time from F_{CLOCK} < 1 kHz to I_{SLEEP} specification is met when transitioning from Active Mode to Sleep Mode.

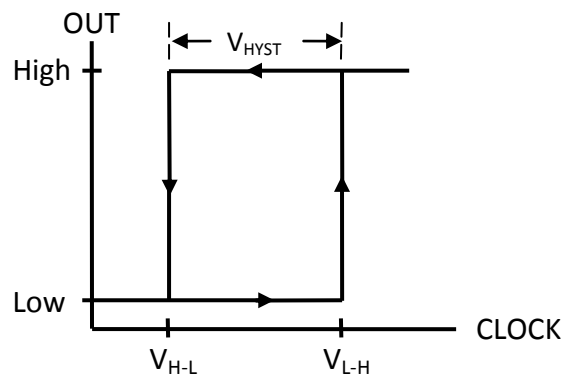
⁵ Time from F_{CLOCK} ≥ 1 MHz to all applicable specifications are met when transitioning from Sleep Mode to Active Mode.

⁶ t_{HOLD} is dependent on C_{LOAD}

3. MICROPHONE STATE DIAGRAM

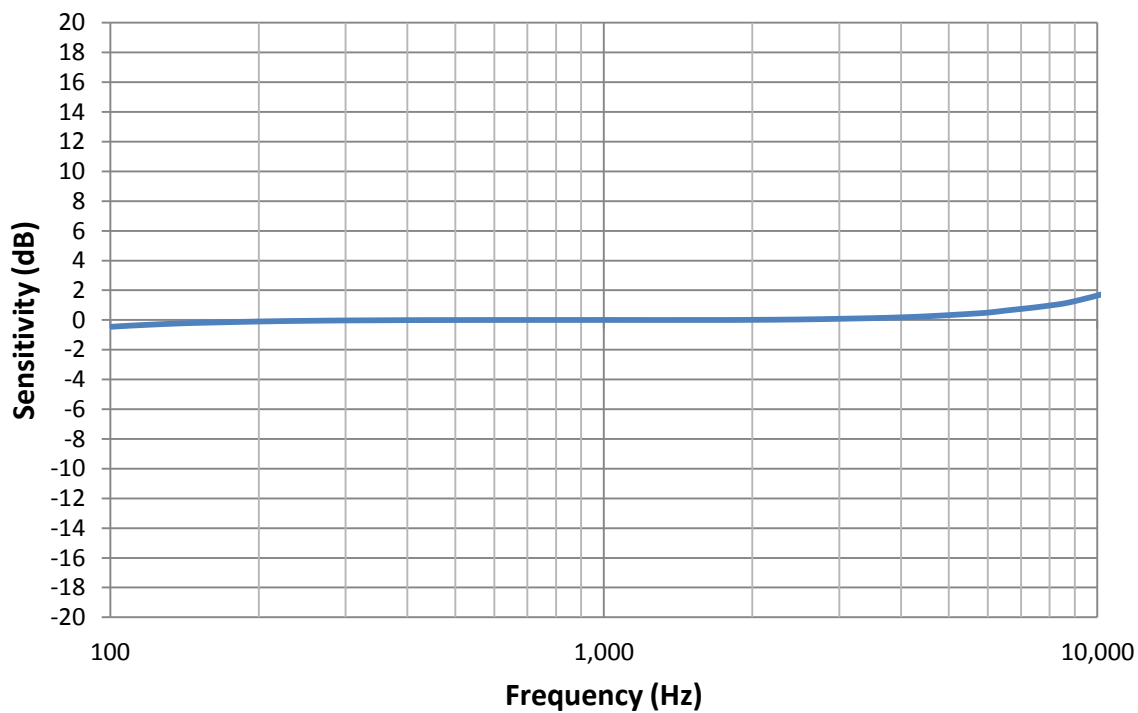


4. HYSTERESIS DIAGRAM

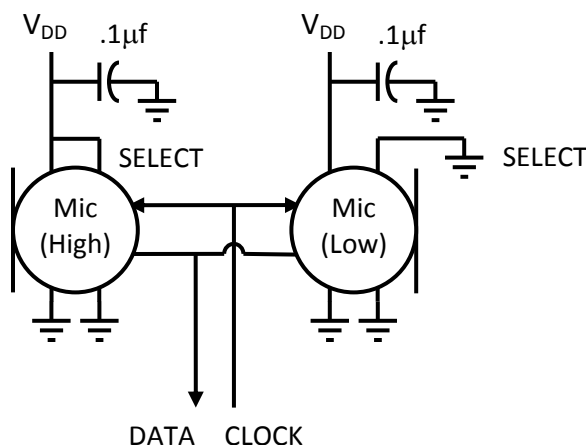


5. FREQUENCY RESPONSE CURVE

**Typical Free Field Response
Normalized to 1kHz**



6. INTERFACE CIRCUIT



Microphone	SELECT	Asserts DATA On	Latch DATA On
Mic (High)	V _{DD}	Rising Clock Edge	Falling Clock Edge
Mic (Low)	GND	Falling Clock Edge	Rising Clock Edge

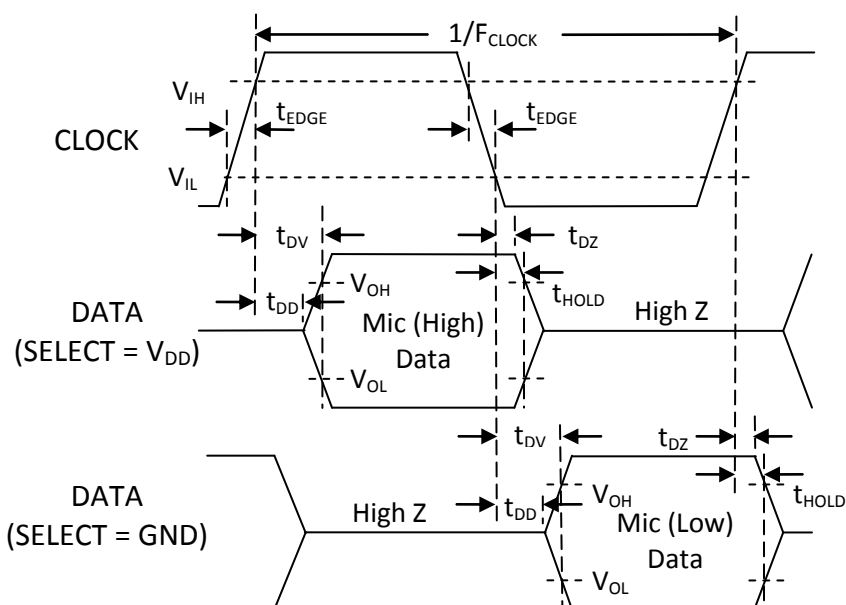
Note: All Ground pins must be connected to ground.

Bypass capacitors should be placed next to each Vdd pin for maximum performance.

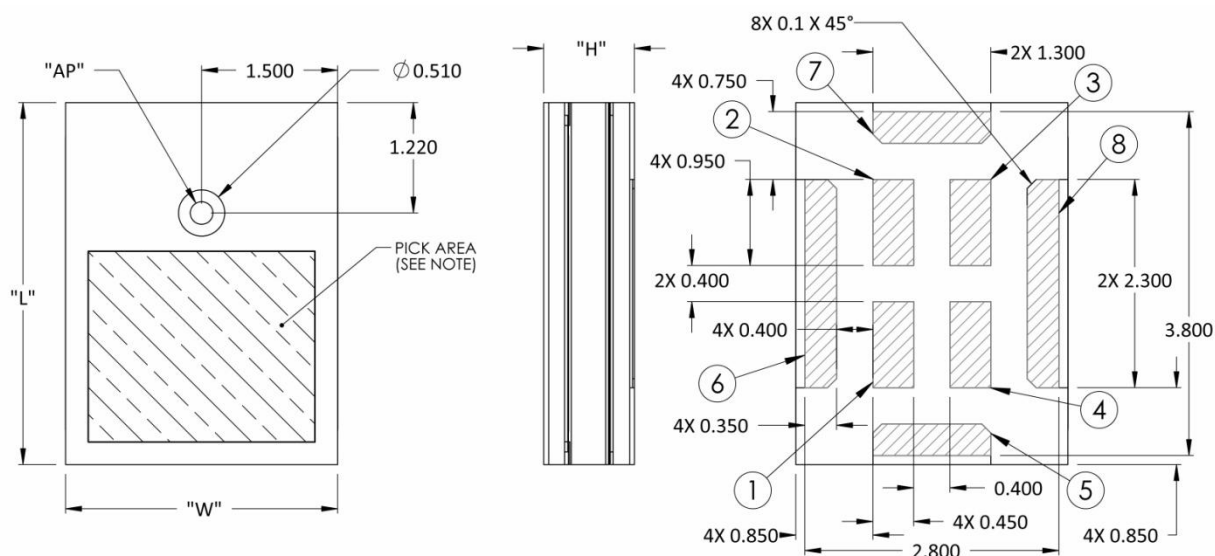
Capacitors near the microphone should not contain Class 2 dielectrics.

Detailed information on acoustic, mechanical, and system integration can be found in the latest *SiSonic™ Design Guide* application note.

7. TIMING DIAGRAM



8. MECHANICAL SPECIFICATIONS



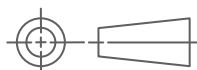
Item	Dimension	Tolerance	Units
Length (L)	4.00	±0.10	mm
Width (W)	3.00	±0.10	mm
Height (H)	1.00	±0.10	mm
Acoustic Port (AP)	Ø0.25	±0.075	mm

Pin #	Pin Name	Type	Description
1	V _{DD}	Power	Power Supply
2	SELECT	Non-Digital Input	Lo/Hi (L/R) Select This pin is internally pulled low.
3	CLOCK	Digital I	Clock Input
4	DATA	Digital O	PDM Output
5	GROUND	Power	Ground
6	GROUND	Power	Ground
7	GROUND	Power	Ground
8	GROUND	Power	Ground

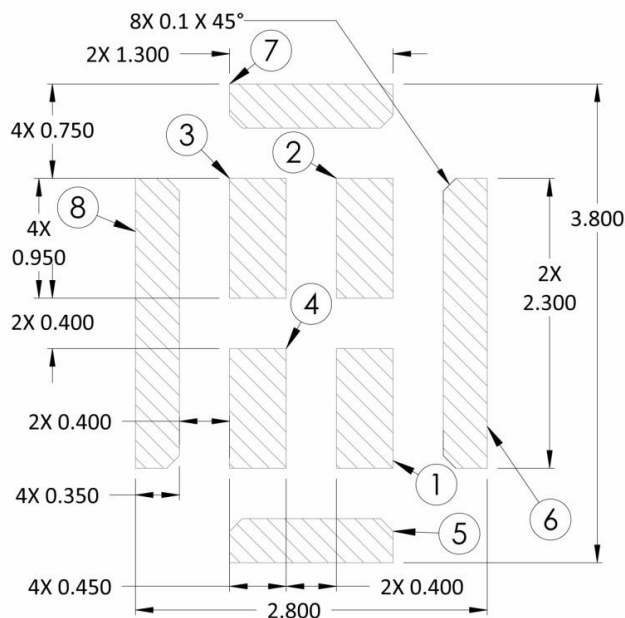
Notes: Pick Area only extends to 0.25 mm of any edge or hole unless otherwise specified.

Dimensions are in millimeters unless otherwise specified.

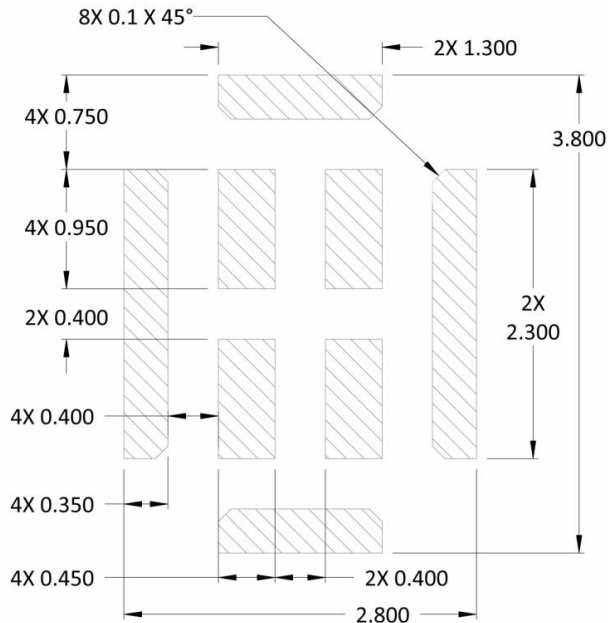
Tolerance is $\pm 0.15\text{mm}$ unless otherwise specified



9. EXAMPLE LAND PATTERN



10. EXAMPLE SOLDER STENCIL PATTERN

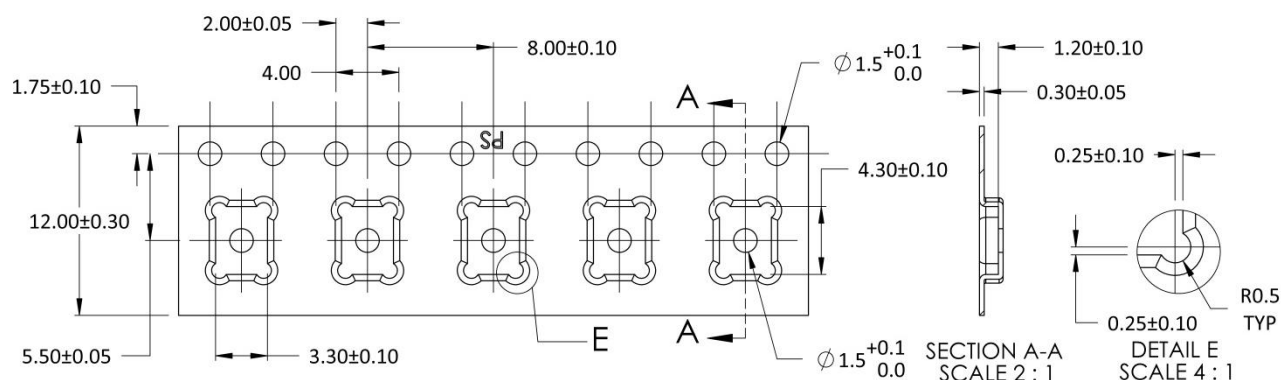


Notes: Dimensions are in millimeters unless otherwise specified.

Detailed information on AP size considerations can be found in the latest *SiSonic™ Design Guide* application note.

Further optimizations based on application should be performed.

11. PACKAGING & MARKETING DETAIL



Model Number	Suffix	Reel Diameter	Quantity Per Reel
SPK0838HT4H-B	-7	13"	5,700

YWW: Year/Week date code

Letter: "K"

Alpha Character A:

“S”: Manufactured in China

“M”: Manufactured in Malaysia

"I": Manufactured in Itasca

Version Number Vx:

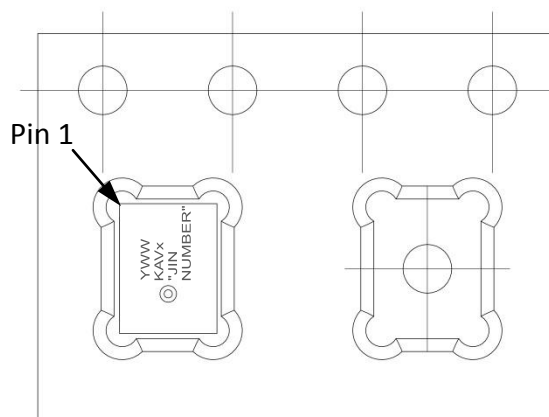
Ex: Pre-proto version number x

Px: Proto & EVT version number x

Mx: Mass production version number x

“JIN NUMBER”:

Unique Job Identification Number for product traceability



Notes: Dimensions are in millimeters unless otherwise specified.

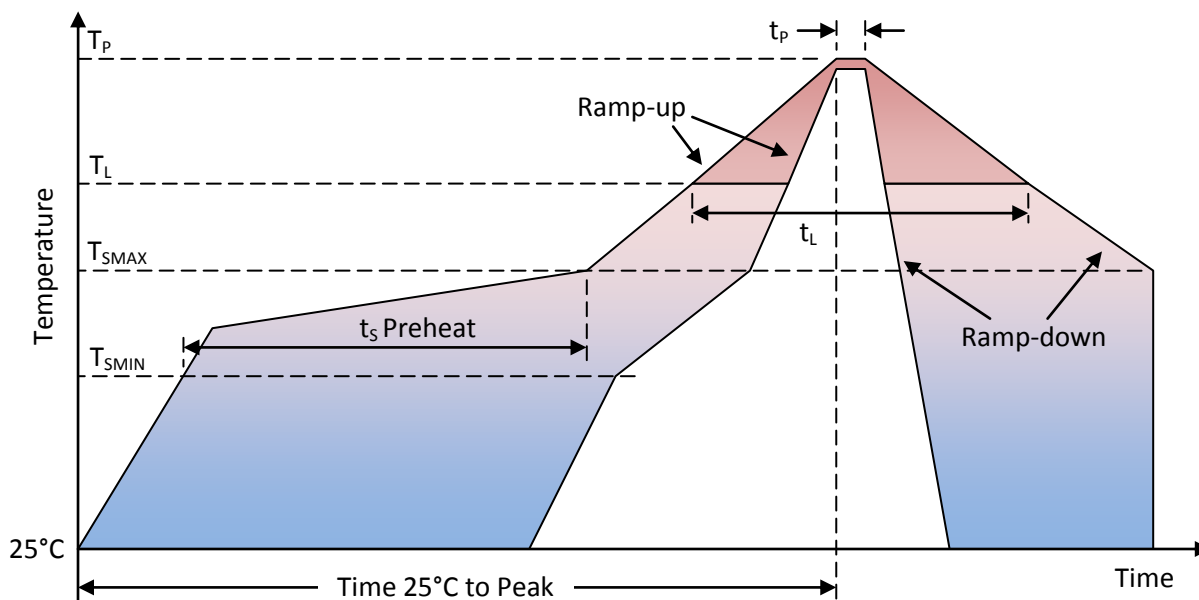
Vacuum pickup only in the pick area indicated in Mechanical Specifications.

Tape & reel per EIA-481.

Labels applied directly to reel and external package.

Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.

12. RECOMMENDED REFLOW PROFILE



Profile Feature	Pb-Free
Average Ramp-up rate (T _S MAX to T _P)	3°C/second max.
Preheat <ul style="list-style-type: none"> Temperature Min (T_SMIN) Temperature Max (T_SMAX) Time (T_SMIN to T_SMAX) (t_s) 	150°C 200°C 60-180 seconds
Time maintained above: <ul style="list-style-type: none"> Temperature (T_L) Time (t_L) 	217°C 60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down rate (T _P to T _S MAX)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max

Notes: Based on IPC/JDEC J-STD-020 Revision C.

All temperatures refer to topside of the package, measured on the package body surface.

13. ADDITIONAL NOTES

- (A) Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.
- (B) MSL (moisture sensitivity level) Class 1.
- (C) Maximum of 3 reflow cycles is recommended.
- (D) In order to minimize device damage:
- Do not board wash or clean after the reflow process.
 - Do not brush board with or without solvents after the reflow process.
 - Do not directly expose to ultrasonic processing, welding, or cleaning.
 - Do not insert any object in port hole of device at any time.
 - Do not apply over 30 psi of air pressure into the port hole.
 - Do not pull a vacuum over port hole of the microphone.
 - Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.

14. MATERIALS STATEMENT

Meets the requirements of the European RoHS directive, 2011/65/EC as amended.

Meets the requirements of the industry-standard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.

Ozone depleting substances are not used in the product or the processes used to make the product including compounds listed in annex A, B, and C of the “Montreal Protocol on Substances that deplete the ozone Layer.”

15. RELIABILITY SPECIFICATIONS

Test	Description
Thermal Shock	100 cycles air-to-air thermal shock from -40°C to +125°C with 15 minute soaks. (IEC 68-2-4)
High Temperature Storage	1,000 hours at +105°C environment (IEC 68-2-2 Test Ba)
Low Temperature Storage	1,000 hours at -40°C environment (IEC 68-2-2 Test Aa)
High Temperature Bias	1,000 hours at +105°C under bias (IEC 68-2-2 Test Ba)
Low Temperature Bias	1,000 hours at -40°C under bias (IEC 68-2-2 Test Aa)
Temperature / Humidity Bias	1,000 hours at +85°C/85% R.H. under bias. (JESD22-A101A-B)
Vibration	4 cycles of 20 to 2,000 Hz sinusoidal sweep with 20 G peak acceleration lasting 12 minutes in X, Y, and Z directions. (Mil-Std-883E, method 2007.2 A)
ESD-HBM	3 discharges of ±2 kV direct contact to I/O pins. (ESD STM5.2)
ESD-LID/GND	3 discharges of ±8 kV direct contact to lid while unit is grounded. (IEC 61000-4-2)
ESD-MM	3 discharges of ±2 kV direct contact to I/O pins. (MIL 883E, Method 3015.7)
Reflow	5 reflow cycles with peak temperature of +260°C
Mechanical Shock	3 pulses of 10,000 G in the X, Y, and Z direction (IEC 68-2-27, Test Ea)

Note: After reliability tests are performed, the sensitivity of the microphones shall not deviate more than 3 dB from its initial value.



SPK0838HT4H-B

16. SPECIFICATIONS REVISIONS

Revision	Specification Changes	Date
A	Initial Release (C10115620)	2/21/2014

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